Cinterion® PLAS9 Wireless Module

LTE Advanced Connectivity With 3G and 2G Fallback
The Gemalto Cinterion® PLAS9 wireless module is built for demanding, high performance IoT applications delivering LTE advanced connectivity under extreme conditions. With Cat. 6 LTE technology, the PLAS9 enables sizzling data speeds of 300 Mbit/s download and 50 Mbit/s uplink plus seamless fallback to 3G and 2G networks. Providing reliable coverage in RF noisy urban areas as well as locations where 4G is still developing, it is an ideal solution for industrial routers and gateways, digital signage, industrial mobile computers and tablets.

Key Features
The PLAS9 provides global coverage and 3G/2G fallback on just two variants, the PLAS9-X and PLAS9-W. The module’s innovative RF concept enables extreme performance and sensitivity and connection stability. MIMO 2x2 antenna interfaces enable consistent performance and improved data speeds. With carrier aggregation, PLAS9 delivers enhanced peak user data rates and optimized use of spectrum for improved connectivity performance.

Gemalto’s proprietary 156 LGA footprint enables optimized heat dissipation that prevents warping while allowing the freedom to select the most beneficial soldering paste and stencil height suited to each individual application.

Industrial Plus Family Benefits
The PLAS9 wireless module is part of the Cinterion Industrial Plus family, which leverages the latest wireless standards to deliver IoT optimized data speeds and Multi Band capabilities to ensure seamless global coverage. They share a common footprint providing a seamless migration path to protect your IoT investment and they are available in local and global variants including 2G, 3G, CDMA, LTE and LTE Advanced. They come with full type approval (FTA) and they are certified by the largest global network operators. All Cinterion modules are compatible with Gemalto’s comprehensive suite of solutions, services and platforms that help enterprises Connect, Secure and Monetize IoT technology.

**LTE Advanced for Demanding Industrial IoT**

- **Carrier Aggregation**
  Delivering a major benefit of LTE Advanced technology, PLAS9 supports carrier aggregation which allows Mobile Network Operators to combine two or more carriers into one data channel for enhanced data capacity, improved peak user performance and optimized use of spectrum.

- **Future Proof and Multi Design Capability**
  Extreme durability, long life components and a unique LGA form factor compatible with past and next generation wireless modules ensures easy migration between wireless standards from a single design, which helps to improve Total Cost of Ownership.

- **Advanced Radio Frequency Design**
  A highly integrated RF design improves reliability and stability in harsh and fluctuating conditions providing excellent performance in noisy urban areas.

**Gemalto M2M Support includes:**
Since 1996, Gemalto has been pioneering market-leading M2M and IoT products that keep our customers on the leading edge of innovation. Unique value added benefits include:

- Trusted partner to 450+ global MNOs ensures products evolve in sync with networks and modules are pre-certified for all global mobile networks
- Core competency in MIM, SIM and eUICC technology allows simplified integration with modules and lower Total Cost of Ownership
- Expert design consulting, local market engineering support and a skilled 24/7 help desk streamline development and deployment
- Global leader in digital security solutions and platforms
- Experienced provider of software solutions for Quality of Service and product life cycle management
- Extensive RF test capabilities and GCF/PTCRB pretests to validate readiness for solution approval process
# Cinterion® PLAS9 Features

## General Features
- **PLAS9:**
  - LTE-FDD/TDD Cat 6 R10, LTE CA R10
  - LTE (FDD 3GPP Release 9; 2x2 DL-MIMO
  - UMTS/HSPA (FDD) 3GPP Release 8; Rx diversity
  - GSM/GPRS/EDGE 3GPP Release 6; DARP/SAIC
- **Drivers:**
  - NDIS/USB driver for Microsoft®, Windows 7™, Windows 8™ and Windows10™
  - RIL driver for devices based on Android OS™
- **Approvals:**
  - R&TTE, GCF, CE, FCC, IC, PTCRB, UL
  - California RoHS
  - AT&T, Telstra and Verizon operator approvals
  - Other local approvals and certifications on request
- **Interfaces (LGA Pads):**
  - 156 pad LGA mount
  - Pads for primary, secondary Antenna
  - USB 3.0 super speed (5 Gbps)
- **Specifications:**
  - LTE Cat. 6DL: max. 300 Mbps, UL: max. 50 Mbps, 2x2 DL MIMO
  - HSPA+ DL Cat. 24 / UL Cat. 6, Dual CarrierDL: max. 42 Mbps, UL: max. 5.76 Mbps
  - EDGE Class 12 data ratesDL: max. 237 kbps, UL: max. 237 kbps
  - GPRS Class 12 data ratesDL: max. 85.6 kbps, UL: max. 85.6 kbps
  - Data only
  - SMS text and PDU mode
- **Special Features:**
  - USB 2.0/3.0 interface supports multiple composite modes and a Linux-/Mac- compliant mode
  - Firmware update via USB
  - 2 UICC (SIM/MIM) interfaces 1.8V / 3V
  - 10 programmable GPIOs including wake-up and lowcurrent indication, 2 ADCs

## Specifications
- **LTE Cat. 6DL:**
  - max. 300 Mbps, UL: max. 50 Mbps, 2x2 DL MIMO
- **HSPA+ DL Cat. 24 / UL Cat. 6, Dual CarrierDL:**
  - max. 42 Mbps, UL: max. 5.76 Mbps
- **EDGE Class 12 data ratesDL:**
  - max. 237 kbps, UL: max. 237 kbps
- **GPRS Class 12 data ratesDL:**
  - max. 85.6 kbps, UL: max. 85.6 kbps
- **Data only:**
  - SMS text and PDU mode
- **Control via AT commands (Hayes, TS 27.007, TS 27.005)**
- **Supply voltage range 3.3 - 4.2 V, highly optimized for minimal power consumption**
- **Dimension: 40 × 32 × 2.8 mm**
- **Operating Temperature Range: -40 °C to +95 °**
- **RoHS, RED and REACH compliant, EuP support**

Gemalto’s complementary offering of solutions, services and platforms helps enterprises unleash the power of the IoT, providing a solid foundation of Trust based on three key pillars:

- **Connect.** The backbone of any IoT solution, Cinterion M2M Modules, SIM/MIMs, Terminals and secure services provide future-proof, reliable connectivity for all vertical market IoT solutions.
- **Secure.** Gemalto’s end-to-end security solutions protect devices, the network and the cloud while managing the entire application lifecycle.
- **Monetize.** Our agile Sentinel monetization solutions enable innovative business models and new revenue streams through embedded licensing, while our secure Application Enablement Platform speeds time to market.

For more information, please visit: www.gemalto/IoT, www.facebook.com/gemalto, or Follow @gemaltolIoT on twitter

The information provided in this brochure contains merely general descriptions or characteristics of performance, which in case of actual use do not always apply as described or which may change as a result of further development of the products. An obligation to provide the respective characteristics shall only exist if expressly agreed in the terms of contract. All product designations may be trademarks or product names of Gemalto M2M GmbH or supplier companies whose use by third parties for their own purposes could violate the rights of the owners. Oracle and Java are registered trademarks of Oracle and/or its affiliates. Other names may be trademarks of their respective owners. ARM9 is a registered trademark of ARM Limited.